



Product Change Notification / SYST-27NIQZ417

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Product Category:

8-bit Microcontrollers

PCN Type:

Document Change

Notification Subject:

ERRATA - ATmega329P/ATmega3290P SEDSC

Affected CPNs:

[SYST-27NIQZ417_Affected_CPN_05122023.pdf](#)

[SYST-27NIQZ417_Affected_CPN_05122023.csv](#)

Notification Text:

SYST-27NIQZ417

Microchip has released a new Errata for the ATmega329P/ATmega3290P SEDSC of devices. If you are using one of these devices please read the document located at [ATmega329P/ATmega3290P SEDSC](#)

Notification Status: Final

Description of Change: Initial document release.

Impacts to Data Sheet: None

Change Implementation Status: Complete

Date Document Changes Effective: 12 May 2023

NOTE: Please be advised that this is a change to the document only the product has not been changed.

Markings to Distinguish Revised from Unrevised Devices: N/A

Attachments:

[ATmega329P/ATmega3290P SEDSC](#)

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Silicon Errata and Data Sheet Clarifications

ATmega329P/ATmega3290P



Introduction

The ATmega329P/3290P devices you have received conform functionally to the current device data sheet (ww1.microchip.com/downloads/en/DeviceDoc/Atmel-8021-AVR-ATmega329P-3290P_Datasheet.pdf), except for the anomalies described in this document. The errata described in this document will likely be addressed in future revisions of the ATmega329P/3290P devices.

Note:

- This document summarizes all the silicon errata issues from all revisions of silicon, previous and current

1. Silicon Issue Summary

- Erratum is not applicable.
- X Erratum is applicable.

Peripheral	Short Description	Valid for Silicon Revision		
		ATmega329P/3290P		
		Rev. A ⁽¹⁾	Rev. B	Rev. C
Device	2.2.1. Using BOD Disable Will Make the Device Reset	X	-	-
Timer	2.3.1. Interrupts May Be Lost When Writing the Timer Registers in the Asynchronous Timer	X	X	X

Note:

1. This revision is the initial release of the silicon.

2. Silicon Errata Issues

2.1 Errata Details

- Erratum is not applicable.
- X Erratum is applicable.

2.2 Device

2.2.1 Using BOD Disable Will Make the Device Reset

If the device enters sleep with the BOD turned off with the BOD disable option enabled, a BOD reset will be generated at wakeup, and the device will reset.

Work Around

Do not use BOD disable.

Affected Silicon Revisions

ATmega329P/3290P		
Rev. A	Rev. B	Rev. C
X	-	-

2.3 Timer

2.3.1 Interrupts May Be Lost When Writing the Timer Registers in the Asynchronous Timer

The interrupt will be lost if writing a timer register that is a synchronous timer clock when the asynchronous Timer/Counter register (TCNTx) is 0x00.

Work Around

Always check that the asynchronous Timer/Counter register neither has the value 0xFF nor 0x00 before writing to the asynchronous Timer Control Register (TCCRx), asynchronous Timer Counter Register (TCNTx), or asynchronous Output Compare Register (OCRx).

Affected Silicon Revisions

ATmega329P/3290P		
Rev. A	Rev. B	Rev. C
X	X	X

3. Data Sheet Clarifications

The following typographic corrections and clarifications are to be noted for the latest version of the device data sheet (DS4000XXXX).

Note: Corrections are shown in **bold**. Where possible, the original bold text formatting has been removed for clarity.

3.1 Errata Section in Data Sheet is no Longer Valid

A clarification for the Errata section in the device data sheet has been made.

The errata content has been moved to a separate document, ATmega329P/3290P (this document).

See the *Silicon Errata Issues* section of this document for the latest errata.

3.2 Power Management and Sleep Modes

3.2.1 Power Management and Sleep Modes

A clarification has been made to the *Active clock domains and wake-up sources in the different sleep modes* table to make the headings visible.

Table 10-1. Active Clock Domains and Wake-Up Sources in the Different Sleep Modes

	Active Clock Domains					Oscillators		Wake-up Sources							Software BOD Disable
Sleep Mode	clk _{CPU}	clk _{FLASH}	clk _{I/O}	clk _{ADC}	clk _{ASY}	Main Clock Source Enabled	Timer Osc Enabled	INT0 and Pin Change	USI Start Condition	LCD Controller	Timer2	SPM/ EEPROM Ready	ADC	Other I/O	
Idle			X	X	X	X	X ⁽²⁾	X	X	X	X	X	X	X	
ADC NRM				X	X	X	X ⁽²⁾	X ⁽³⁾	X	X ⁽²⁾	X ⁽²⁾	X	X		
Power-down								X ⁽³⁾	X						X
Power-save					X		X	X ⁽³⁾	X	X	X				X
Standby ⁽¹⁾						X		X ⁽³⁾	X						X

Notes:

1. Only recommended with external XTAL or resonator selected as clock source.
2. If either the LCD controller or Timer/Counter2 is running in asynchronous mode.
3. For INT0, only level interrupt.

3.3 Interrupts

3.3.1 Interrupt Vectors in ATmega329P/3290P

A clarification for the source names of the Interrupt vectors has been made to comply with the header file naming convention.

Table 3-1. Reset and Interrupt Vectors in ATmega329P

Vector No	Program Address ⁽²⁾	Source	Interrupts definition
1	0x0000 ⁽¹⁾	RESET	External pin, Power-on Reset, Brown-out Reset, Watchdog System Reset and JTAG AVR Reset
2	0x0002	INT0	External Interrupt Request 0
3	0x0004	PCINT0	Pin Change Interrupt Request 0
4	0x0006	PCINT1	Pin Change Interrupt Request 1
5	0x0008	TIMER2_COMP	Timer/Counter2 Compare Match
6	0x000A	TIMER2_OVF	Timer/Counter2 Overflow
7	0x000C	TIMER1_CAPT	Timer/Counter1 Capture Event
8	0x000E	TIMER1_COMPA	Timer/Counter1 Compare Match A
9	0x0010	TIMER1_COMPB	Timer/Counter1 Compare Match B
10	0x0012	TIMER1_OVF	Timer/Counter1 Overflow
11	0x0014	TIMER0_COMP	Timer/Counter0 Compare Match
12	0x0016	TIMER0_OVF	Timer/Counter0 Overflow
13	0x0018	SPI_STC	SPI Serial Transfer Complete
14	0x001A	USART0_RX	USART Receive complete
15	0x001C	USART0_UDRE	USART Data Register Empty
16	0x001E	USART0_TX	USART Transmit complete
17	0x0020	USI_START	USI Start Condition
18	0x0022	USI_OVERFLOW	USI Overflow
19	0x0024	ANALOG_COMP	Analog Comparator
20	0x0026	ADC	ADC Conversion complete
21	0x0028	EE_READY	EEPROM Ready
22	0x002A	SPM_READY	Store Program Memory Ready
23	0x002C	LCD	LCD Start of Frame

Notes:

1. When the BOOTRST fuse is programmed, the device will jump to the boot loader address at Reset. See “Boot Loader Support – Read-While-Write Self- Programming”.
2. When setting the IVSEL bit in MCUCR, Interrupt Vectors will be moved to the start of the boot Flash section. The address of each Interrupt Vector will then be the address in this table added to the start address of the boot Flash section.

The table below shows the Reset and Interrupt Vectors placement for the various combinations of the BOOTRST and IVSEL settings. If the program never enables an interrupt source, the Interrupt Vectors are unused, and regular program codes can be placed at these locations. This is also the case if the Reset Vector is in the Application section while the Interrupt Vectors are in the Boot section or vice versa.

Table 3-2. Reset and Interrupt Vectors Placement

BOOTRST ⁽¹⁾	IVSEL	Reset Address	Interrupt Vectors Start Address
1	0	0x000	0x002
1	1	0x000	Boot Reset Address + 0x0002
0	0	Boot Reset Address	0x002
0	1	Boot Reset Address	Boot Reset Address + 0x0002

Note: 1. For the BOOTRST Fuse, “1” means unprogrammed, while “0” means programmed.

The most typical and general program setup for the Reset and Interrupt Vector Addresses is:

Address	Labels	Code	Comments
0x0000		jmp	RESET ; Reset Handler
0x0002		jmp	INT0 ; IRQ0 Handler
0x0004		jmp	PCINT0 ; PCINT0 Handler
0x0006		jmp	PCINT1 ; PCINT1 Handler
0x0008		jmp	TIMER2_COMP ; Timer2 CompareA Handler
0x000A		jmp	TIMER2_OVF ; Timer2 Overflow Handler
0x000C		jmp	TIMER1_CAPT ; Timer1 Capture Handler
0x000E		jmp	TIMER1_COMPA ; Timer1 CompareA Handler
0x0010		jmp	TIMER1_COMPB ; Timer1 CompareB Handler
0x0012		jmp	TIMER1_OVF ; Timer1 Overflow Handler
0x0014		jmp	TIMER0_COMP ; Timer0 Compare Handler
0x0016		jmp	TIMER0_OVF ; Timer0 Overflow Handler
0x0018		jmp	SPI_STC ; SPI Transfer Complete Handler
0x001A		jmp	USART0_RX ; USART RX Complete Handler
0x001C		jmp	USART0_UDRE ; USART UDR Empty Handler
0x0020		jmp	USI_START ; USI Start Condition Handler
0x0022		jmp	USI_OVERFLOW ; USI Overflow Handler
0x0024		jmp	ANALOG_COMP ; Analog Comparator Handler
0x0026		jmp	ADC ; ADC Conversion Complete Handler
0x0028		jmp	EE_READY ; EEPROM Ready Handler
0x002A		jmp	SPM_READY ; SPM Ready Handler
0x002C		jmp	LCD ; LCD Start of Frame Handler
;			
0x0034	RESET:	ldi	r16,high(RAMEND) ; Main program start
0x0035		out	SPH,r16 ; Set Stack Pointer to top of RAM
0x0036		ldi	r16,low(RAMEND)
0x0037		out	SPL,r16
0x0038		sei	; Enable interrupts
0x0039		<instr>	xxx
...

When the BOOTRST Fuse is unprogrammed, the Boot section size is set to 2 KB, and the MCUCR.IVSEL is set before any interrupts are enabled, the most typical and general program setup for the Reset and Interrupt Vector Addresses is:

Address	Labels	Code	Comments
0x0000	RESET:	ldi	r16,high(RAMEND) ; Main program start
0x0001		out	SPH,r16 ; Set Stack Pointer to top of RAM
0x0002		ldi	r16,low(RAMEND)
0x0003		out	SPL,r16
0x0004		sei	; Enable interrupts
0x0005		<instr>	xxx
;			
.org 0x1C02			
0x1C02		jmp	EXT_INT0 ; IRQ0 Handler
0x1C04		jmp	EXT_INT1 ; IRQ1 Handler
...		...	;
0x1C32		jmp	SPM_RDY ; SPM Ready Handler

When the BOOTRST Fuse is programmed and the Boot section size is set to 2 KB, the most typical and general program setup for the Reset and Interrupt Vector Addresses is:

Address	Labels	Code	Comments
.org 0x0002			
0x0002		jmp	EXT_INT0 ; IRQ0 Handler
0x0004		jmp	EXT_INT1 ; IRQ1 Handler
...		...	;
0x0032		jmp	SPM_RDY ; SPM Ready Handler
;			
.org 0x1C0C			
0x1C00	RESET:	ldi	r16,high(RAMEND) ; Main program start
0x1C01		out	SPH,r16 ; Set Stack Pointer to top of RAM
0x1C02		ldi	r16,low(RAMEND)
0x1C03		out	SPL,r16
0x1C04		sei	; Enable interrupts
0x1C05		<instr>	xxx

When the BOOTRST Fuse is programmed, the Boot section size is set to 2 KB and the MCUCR.IVSEL is set before any interrupts are enabled, the most typical and general program setup for the Reset and Interrupt Vector Addresses is:

Address	Labels	Code	Comments
;			
.org 0x1C0C			
0x1C00		jmp RESET	; Reset handler
0x1C02		jmp EXT_INT0	; IRQ0 Handler
0x1C04		jmp EXT_INT1	; IRQ1 Handler
...		...	;
0x1C32		jmp SPM_RDY	; SPM Ready Handler
;			
0x1C34	RESET:	ldi r16,high(RAMEND)	; Main program start
0x1C35		out SPH,r16	; Set Stack Pointer to top of RAM
0x1C36		ldi r16,low(RAMEND)	
0x1C37		out SPL,r16	
0x1C38		sei	; Enable interrupts
0x1C39		<instr> xxx	

Table 3-3. Reset and Interrupt Vectors in ATmega3290P

Vector No	Program Address ⁽²⁾	Source	Interrupts definition
1	0x0000 ⁽¹⁾	RESET	External pin, Power-on Reset, Brown-out Reset, Watchdog Reset and JTAG AVR Reset.
2	0x0002	INT0	External Interrupt Request 0
3	0x0004	PCINT0	Pin Change Interrupt Request 0
4	0x0006	PCINT1	Pin Change Interrupt Request 1
5	0x0008	TIMER2_COMP	Timer/Counter2 Compare Match
6	0x000A	TIMER2_OVF	Timer/Counter2 Overflow
7	0x000C	TIMER1_CAPT	Timer/Counter1 Capture Event
8	0x000E	TIMER1_COMPA	Timer/Counter1 Compare Match A
9	0x0010	TIMER1_COMPB	Timer/Counter1 Compare Match B
10	0x0012	TIMER1_OVF	Timer/Counter1 Overflow
11	0x0014	TIMER0_COMP	Timer/Counter0 Compare Match
12	0x0016	TIMER0_OVF	Timer/Counter0 Overflow
13	0x0018	SPI_STC	SPI Serial Transfer Complete
14	0x001A	USART0_RX	USART0 Receive complete
15	0x001C	USART0_UDRE	USART Data Register Empty
16	0x001E	USART0_TX	USART Transmit complete
17	0x0020	USI_START	USI Start condition
18	0x0022	USI_OVERFLOW	USI Overflow
19	0x0024	ANALOG_COMP	Analog Comparator
20	0x0026	ADC	ADC Conversion complete
21	0x0028	EE_READY	EEPROM Ready
22	0x002A	SPM_READY	Store Program Memory Ready
23	0x002C	LCD	LCD Start of Frame
24	0x002E	PCINT2	Pin Change Interrupt Request 2
25	0x0030	PCINT3	Pin Change Interrupt Request 3

Notes:

1. When the BOOTRST fuse is programmed, the device will jump to the boot loader address at Reset. See “Boot Loader Support – Read-While-Write Self- Programming”.
2. When setting the IVSEL bit in MCUCR, Interrupt Vectors will be moved to the start of the boot Flash section. The address of each Interrupt Vector will then be the address in this table added to the start address of the boot Flash section.

The most typical and general program setup for the Reset and Interrupt Vector Addresses is:

Address	Labels	Code	Comments
0x0000		jmp RESET	; Reset Handler
0x0002		jmp INT0	; IRQ0 Handler
0x0004		jmp PCINT0	; PCINT0 Handler
0x0006		jmp PCINT1	; PCINT1 Handler
0x0008		jmp TIMER2_COMP	; Timer2 CompareA Handler
0x000A		jmp TIMER2_OVF	; Timer2 Overflow Handler
0x000C		jmp TIMER1_CAPT	; Timer1 Capture Handler
0x000E		jmp TIMER1_COMPA	; Timer1 CompareA Handler
0x0010		jmp TIMER1_COMPB	; Timer1 CompareB Handler
0x0012		jmp TIMER1_OVF	; Timer1 Overflow Handler
0x0014		jmp TIMER0_COMP	; Timer0 Compare Handler
0x0016		jmp TIMER0_OVF	; Timer0 Overflow Handler
0x0018		jmp SPI_STC	; SPI Transfer Complete Handler
0x001A		jmp USART0_RX	; USART RX Complete Handler
0x001C		jmp USART0_UDRE	; USART UDR Empty Handler
0x0020		jmp USI_START	; USI Start Condition Handler
0x0022		jmp USI_OVERFLOW	; USI Overflow Handler
0x0024		jmp ANALOG_COMP	; Analog Comparator Handler
0x0026		jmp ADC	; ADC Conversion Complete Handler
0x0028		jmp EE_READY	; EEPROM Ready Handler
0x002A		jmp SPM_READY	; SPM Ready Handler
0x002C		jmp LCD	; LCD Start of Frame Handler
0x002E		jmp PCINT2	; PCINT2 Handler Handler
0x0030		jmp PCINT3	; PCINT3 Handler Handler
;			
0x0034	RESET:	ldi r16,high(RAMEND)	; Main program start
0x0035		out SPH,r16	; Set Stack Pointer to top of RAM
0x0036		ldi r16,low(RAMEND)	
0x0037		out SPL,r16	
0x0038		sei	; Enable interrupts
0x0039		<instr> xxx	
...

3.4 Electrical Characteristics – TA = -40°C to 85°C

3.4.1 Analog Input Offset Voltage (TA = -40°C to 85°C)

A clarification has been made for the “Analog Comparator Input Offset Voltage”.

Table 3-4. TA = -40°C to 85°C, VCC = 1.8V to 5.5V (unless otherwise noted)

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
V _{IL}	Input low voltage, except XTAL1 pin	V _{CC} = 1.8-2.4V V _{CC} = 2.4-5.5V	-0.5 -0.5		0.2V _{CC} ⁽¹⁾ 0.3V _{CC} ⁽¹⁾	V
V _{IL1}	Input low voltage, XTAL1 pin	V _{CC} = 1.8-5.5V	-0.5		0.1V _{CC} ⁽¹⁾	
V _{IH}	Input high voltage, except XTAL1 and RESET pins	V _{CC} = 1.8-2.4V V _{CC} = 2.4-5.5V	0.7V _{CC} ⁽²⁾ 0.6V _{CC} ⁽²⁾		V _{CC} + 0.5 V _{CC} + 0.5	
V _{IH1}	Input high voltage, XTAL1 pin	V _{CC} = 1.8-2.4V V _{CC} = 2.4-5.5V	0.8V _{CC} ⁽²⁾ 0.7V _{CC} ⁽²⁾		V _{CC} + 0.5 V _{CC} + 0.5	
V _{IH2}	Input high voltage, RESET pin	V _{CC} = 1.8-5.5V	0.85V _{CC} ⁽²⁾		V _{CC} + 0.5	
V _{OL}	Output low voltage ⁽³⁾ , Port A, C, D, E, F, G, H, J	I _{OL} = 10 mA, V _{CC} = 5V I _{OL} = 5 mA, V _{CC} = 3V			0.9 0.6	
V _{OL1}	Output low voltage ⁽³⁾ , Port B	I _{OL} = 20 mA, V _{CC} = 5V I _{OL} = 10 mA, V _{CC} = 3V			0.9 0.6	
V _{OH}	Output high voltage ⁽⁴⁾ , Port A, C, D, E, F, G, H, J	I _{OH} = -10 mA, V _{CC} = 5V I _{OH} = -5 mA, V _{CC} = 3V	4.2 2.3			
V _{OH1}	Output high voltage ⁽⁴⁾ , Port B	I _{OH} = -20 mA, V _{CC} = 5V I _{OH} = -10 mA, V _{CC} = 3V	4.2 2.3			
I _{IL}	Input leakage current I/O Pin	V _{CC} = 5.5V, pin low (absolute value)			1	μA
I _{IH}	Input leakage current I/O Pin	V _{CC} = 5.5V, pin high (absolute value)			1	

.....continued

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
R _{RST}	Reset pull-up resistor		20		100	kΩ
R _{PU}	I/O Pin pull-up resistor		20		100	kΩ
V _{ACIO}	Analog comparator input offset voltage	V _{CC} = 5V V _{in} = V _{CC} /2		< 10	40	mV
V _{ACIO}	Analog comparator input offset voltage	V _{CC} < 3.6V V _{in} < 0.5V		<15	60 ⁽⁵⁾	mV
V _{ACIO}	Analog comparator input offset voltage	V _{CC} > 3.6V V _{in} < 0.5V		<15	500 ⁽⁵⁾	mV
I _{ACLK}	Analog comparator	V _{CC} = 5V V _{in} = V _{CC} /2	-50		50	nA
t _{ACID}	Analog comparator propagation delay	V _{CC} = 2.7V V _{CC} = 4.0V		750 500		ns

Notes:

1. "Max" means the highest value where the pin is ensured to be read as low.
2. "Min" means the lowest value where the pin is ensured to be read as high.
3. Although each I/O port can sink more than the test conditions (20 mA at V_{CC} = 5V, 10 mA at V_{CC} = 3V for Port B and 10 mA at V_{CC} = 5V, 5 mA at V_{CC} = 3V for all other ports) under steady-state conditions (non-transient), observe the following:
 - TQFP and QFN/MLF Package:
 - i. The sum of all I_{OL} may not exceed 400 mA for all ports.
 - ii. The sum of all I_{OL} may not exceed 100 mA for ports A0 - A7, C4 - C7, and G2.
 - iii. The sum of all I_{OL} may not exceed 100 mA for ports B0 - B7, E0 - E7, and G3 - G5.
 - iv. The sum of all I_{OL} may not exceed 100 mA for ports D0 - D7, C0 - C3, and G0 - G1.
 - v. The sum of all I_{OL} may not exceed 100 mA for ports F0 - F7.

If I_{OL} exceeds the test condition, V_{OL} may exceed the related specification. Pins are not ensured to sink current higher than the listed test condition.
4. Although each I/O port can source more than the test conditions (20 mA at V_{CC} = 5V, 10 mA at V_{CC} = 3V for Port B and 10 mA at V_{CC} = 5V, 5 mA at V_{CC} = 3V for all other ports) under steady-state conditions (non-transient), observe the following:
 - TQFP and QFN/MLF Package:
 - i. The sum of all I_{OH} may not exceed 400 mA for all ports.
 - ii. The sum of all I_{OH} may not exceed 100 mA for ports A0 - A7, C4 - C7, and G2.
 - iii. The sum of all I_{OH} may not exceed 100 mA for ports B0 - B7, E0 - E7, and G3 - G5.
 - iv. The sum of all I_{OH} may not exceed 100 mA for ports D0 - D7, C0 - C3, and G0 - G1.
 - v. The sum of all I_{OH} may not exceed 100 mA for ports F0 - F7.

If I_{OH} exceeds the test condition, V_{OH} may exceed the related specification. Pins are not ensured to source current higher than the listed test condition.
5. **These values are based on characterization. The maximum limit in production can, therefore, not be assured.**

3.4.2 Power-Down Specification Limit ($T_A = -40^{\circ}\text{C}$ to 85°C)

A clarification for the power-down specification limit has been made. This clarification has corrections that are impractical to mark in bold. The following tables in this section contain the most current information and notes.

Table 3-5. ATmega329P DC Characteristics. $T_A = -40^{\circ}\text{C}$ to 85°C , $V_{CC} = 1.8\text{V}$ to 5.5V (unless otherwise noted)

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
I_{CC}	Power supply current ⁽¹⁾	Active 1 MHz, $V_{CC} = 2\text{V}$		0.5	0.75	mA
		Active 4 MHz, $V_{CC} = 3\text{V}$		2.6	3.5	
		Active 8 MHz, $V_{CC} = 5\text{V}$		9.0	12.0	
		Idle 1 MHz, $V_{CC} = 2\text{V}$		0.14	0.25	
		Idle 4 MHz, $V_{CC} = 3\text{V}$		0.75	1.5	
		Idle 8 MHz, $V_{CC} = 5\text{V}$		2.9	5.0	
	Power-save mode ⁽²⁾	32.768 kHz TOSC enabled, $V_{CC} = 1.8\text{V}$		0.75		μA
		32.768 kHz TOSC enabled, $V_{CC} = 3\text{V}$		1.0		
	Power-down mode ⁽²⁾	WDT enabled, $V_{CC} = 3\text{V}$		6.7	15.0	
		WDT disabled, $V_{CC} = 3\text{V}$		0.2	2.0	

Notes:

1. All bits are set in the 'Power Reduction Register' on page 43.
2. **Maximum and Typical values for 25°C . Maximum values are test limits in production.**

Table 3-6. ATmega3290P DC Characteristics. $T_A = -40^{\circ}\text{C}$ to 85°C , $V_{CC} = 1.8\text{V}$ to 5.5V (unless otherwise noted)

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
I_{CC}	Power supply current ⁽¹⁾	Active 1 MHz, $V_{CC} = 2\text{V}$		0.5	0.75	mA
		Active 4 MHz, $V_{CC} = 3\text{V}$		2.6	3.5	
		Active 8 MHz, $V_{CC} = 5\text{V}$		9.0	12.0	
		Idle 1 MHz, $V_{CC} = 2\text{V}$		0.14	0.25	
		Idle 4 MHz, $V_{CC} = 3\text{V}$		0.75	1.5	
		Idle 8 MHz, $V_{CC} = 5\text{V}$		2.9	5.0	
	Power-save mode ⁽²⁾	32.768 kHz TOSC enabled, $V_{CC} = 1.8\text{V}$		0.75		μA
		32.768 kHz TOSC enabled, $V_{CC} = 3\text{V}$		1.0		
	Power-down mode ⁽²⁾	WDT enabled, $V_{CC} = 3\text{V}$		6.7	15.0	
		WDT disabled, $V_{CC} = 3\text{V}$		0.2	2.0	

Notes:

1. All bits are set in the 'Power Reduction Register' on page 43.
2. **Maximum and Typical values for 25°C . Maximum values are test limits in production.**

3.5 Electrical Characteristics – TA = -40°C to 105°C

3.5.1 Analog Input Offset Voltage (TA = -40°C to 105°C)

A clarification has been made for the “Analog Comparator Input Offset Voltage” in the following table.

Table 3-7. TA = -40°C to 105°C, VCC = 1.8V to 5.5V (unless otherwise noted)

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
V _{IL}	Input low voltage except XTAL1 and RESET pins	V _{CC} = 1.8-2.4V V _{CC} = 2.4-5.5V	-0.5 -0.5		0.2V _{CC} ⁽¹⁾ 0.3V _{CC} ⁽¹⁾	V
V _{IL1}	Input low voltage XTAL1 pins	V _{CC} = 1.8-5.5V	-0.5		0.1V _{CC} ⁽¹⁾	
V _{IL2}	Input low voltage, RESET pins	V _{CC} = 1.8-5.5V	-0.5		0.1V _{CC} ⁽¹⁾	
V _{IH}	Input high voltage except XTAL1 and RESET pins	V _{CC} = 1.8-2.4V V _{CC} = 2.4-5.5V	0.7V _{CC} ⁽²⁾ 0.6V _{CC} ⁽²⁾		V _{CC} + 0.5 V _{CC} + 0.5	
V _{IH1}	Input high voltage, XTAL1 pin	V _{CC} = 1.8-2.4V V _{CC} = 2.4-5.5V	0.8V _{CC} ⁽²⁾ 0.7V _{CC} ⁽²⁾		V _{CC} + 0.5 V _{CC} + 0.5	
V _{IH2}	Input high voltage, RESET pins	V _{CC} = 1.8-5.5V	0.9V _{CC} ⁽²⁾		V _{CC} + 0.5	
V _{OL}	Output low voltage ⁽³⁾ , Port A, C, D, E, F, G	I _{OL} = 10 mA, V _{CC} = 5V I _{OL} = 5 mA, V _{CC} = 3V			0.7/1.0 ⁽⁵⁾ 0.5/0.7 ⁽⁵⁾	
V _{OL1}	Output low voltage ⁽³⁾ , Port B	I _{OL} = 20 mA, V _{CC} = 5V I _{OL} = 10 mA, V _{CC} = 3V			0.7/1.0 ⁽⁵⁾ 0.5/0.7 ⁽⁵⁾	
V _{OH}	Output high voltage ⁽⁴⁾ , Port A, C, D, E, F, G	I _{OH} = -10 mA, V _{CC} = 5V I _{OH} = -5 mA, V _{CC} = 3V	4.2 2.3			
V _{OH1}	Output high voltage ⁽⁴⁾ , Port B	I _{OH} = -20 mA, V _{CC} = 5V I _{OH} = -10 mA, V _{CC} = 3V	4.2 2.3			
I _{IL}	Input leakage current I/O Pin	V _{CC} = 5.5V, pin low (absolute value)			1	μA
I _{IH}	Input leakage current I/O Pin	V _{CC} = 5.5V, pin high (absolute value)			1	
R _{RST}	Reset pull-up resistor		20		60	kΩ
R _{PU}	I/O Pin pull-up resistor		20		50	
V _{ACIO}	Analog comparator input offset voltage	V _{CC} = 5V V _{in} = V _{CC} /2		< 10	40	mV
V_{ACIO}	Analog comparator input offset voltage	V_{CC} < 3.6V V_{in} < 0.5V		<15	60⁽⁶⁾	mV
V_{ACIO}	Analog comparator input offset voltage	V_{CC} > 3.6V V_{in} < 0.5V		<15	500⁽⁶⁾	mV
I _{ACLK}	Analog comparator	V _{CC} = 5V V _{in} = V _{CC} /2	-50		50	nA
t _{ACID}	Analog comparator propagation delay	V _{CC} = 2.7V V _{CC} = 4.0V		750 500		ns

Notes:

1. "Max" means the highest value where the pin is ensured to be read as low.
2. "Min" means the lowest value where the pin is ensured to be read as high.
3. Although each I/O port can sink more than the test conditions (20 mA at $V_{CC} = 5V$, 10 mA at $V_{CC} = 3V$ for Port B and 10 mA at $V_{CC} = 5V$, 5 mA at $V_{CC} = 3V$ for all other ports) under steady-state conditions (non-transient), the following must be observed.
 - TQFP and QFN/MLF Package:
 - i. The sum of all I_{OL} may not exceed 400 mA for all ports.
 - ii. The sum of all I_{OL} may not exceed 100 mA for ports A0 - A7, C4 - C7, and G2.
 - iii. The sum of all I_{OL} may not exceed 100 mA for ports B0 - B7, E0 - E7, and G3 - G5.
 - iv. The sum of all I_{OL} may not exceed 100 mA for ports D0 - D7, C0 - C3, and G0 - G1.
 - v. The sum of all I_{OL} may not exceed 100 mA for ports F0 - F7.

If I_{OL} exceeds the test condition, V_{OL} may exceed the related specification. Pins are not ensured to sink current higher than the listed test condition.
4. Although each I/O port can source more than the test conditions (20 mA at $V_{CC} = 5V$, 10 mA at $V_{CC} = 3V$ for Port B and 10 mA at $V_{CC} = 5V$, 5 mA at $V_{CC} = 3V$ for all other ports) under steady-state conditions (non-transient), observe the following:
 - TQFP and QFN/MLF Package:
 - i. The sum of all I_{OH} may not exceed 400 mA for all ports.
 - ii. The sum of all I_{OH} may not exceed 100 mA for ports A0 - A7, C4 - C7, and G2.
 - iii. The sum of all I_{OH} may not exceed 100 mA for ports B0 - B7, E0 - E7, and G3 - G5.
 - iv. The sum of all I_{OH} may not exceed 100 mA for ports D0 - D7, C0 - C3, and G0 - G1.
 - v. The sum of all I_{OH} may not exceed 100 mA for ports F0 - F7.

If I_{OH} exceeds the test condition, V_{OH} may exceed the related specification. Pins are not ensured to source current higher than the listed test condition.
5. Largest value for ATmega329P and ATmega3290P.
6. **These values are based on characterization. The maximum limit in production can, therefore, not be assured.**

3.5.2 Power-Down Specification Limit ($T_A = -40^{\circ}\text{C}$ to 105°C)

A clarification for the power-down specification limit has been made. This clarification has corrections that are impractical to mark in bold. The following tables in this section contain the most current information and notes.

Table 3-8. Current Consumption ATmega329P $T_A = -40^{\circ}\text{C}$ to 105°C , $V_{CC} = 1.8\text{V}$ to 5.5V (unless otherwise noted)

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
I_{CC}	Power supply current ⁽¹⁾	Active 1 MHz, $V_{CC} = 2\text{V}$		0.4	0.85	mA
		Active 4 MHz, $V_{CC} = 3\text{V}$		2.3	3.8	
		Active 8 MHz, $V_{CC} = 5\text{V}$		9.0	14.0	
		Idle 1 MHz, $V_{CC} = 2\text{V}$		0.1	0.3	
		Idle 4 MHz, $V_{CC} = 3\text{V}$		0.8	1.65	
		Idle 8 Hz, $V_{CC} = 5\text{V}$		3.1	5.5	
	Power-save mode ⁽²⁾	32.768 kHz TOSC enabled, $V_{CC} = 1.8\text{V}$		0.6	1.8	μA
		32.768 kHz TOSC enabled, $V_{CC} = 3\text{V}$		0.9	3.0	
	Power-down mode ⁽²⁾	WDT enabled, $V_{CC} = 3\text{V}$		7	20	
		WDT disabled, $V_{CC} = 3\text{V}$		0.2	5.0	

Notes:

1. All bits are set in the 'Power Reduction Register' **on page 43**.
2. **Maximum and Typical values for 25°C . Maximum values are test limits in production.**

Table 3-9. Current Consumption ATmega3290P $T_A = -40^{\circ}\text{C}$ to 105°C , $V_{CC} = 1.8\text{V}$ to 5.5V (unless otherwise noted)

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
I_{CC}	Power supply current ⁽¹⁾	Active 1 MHz, $V_{CC} = 2\text{V}$		0.4	0.85	mA
		Active 4 MHz, $V_{CC} = 3\text{V}$		2.3	3.8	
		Active 8 MHz, $V_{CC} = 5\text{V}$		9.0	14.0	
		Idle 1 MHz, $V_{CC} = 2\text{V}$		0.1	0.3	
		Idle 4 MHz, $V_{CC} = 3\text{V}$		0.8	1.65	
		Idle 8 MHz, $V_{CC} = 5\text{V}$		3.1	5.5	
	Power-save mode ⁽²⁾	32.768 kHz TOSC enabled, $V_{CC} = 1.8\text{V}$		0.6	1.8	μA
		32.768 kHz TOSC enabled, $V_{CC} = 3\text{V}$		0.9	3.0	
	Power-down mode ⁽²⁾	WDT enabled, $V_{CC} = 3\text{V}$		7.0	20	
		WDT disabled, $V_{CC} = 3\text{V}$		0.2	5.0	

Notes:

1. All bits are set in the 'Power Reduction Register' **on page 43**.
2. **Maximum and Typical values for 25°C . Maximum values are test limits in production.**

4. Document Revision History

Note: The document revision is independent of the silicon revision.

4.1 Revision History

Doc Rev.	Date	Comments
A	4/2023	<p>Initial document release.</p> <ul style="list-style-type: none"> Content moved from the data sheet and restructured to the new document template Updated the die revision list to reflect die revisions in production <p>Silicon Errata added:</p> <ul style="list-style-type: none"> 2.2.1. Using BOD Disable Will Make the Device Reset 2.3.1. Interrupts May Be Lost When Writing the Timer Registers in the Asynchronous Timer <p>Data Sheet Clarifications added:</p> <ul style="list-style-type: none"> The Errata section in the data sheet is no longer valid 3.2.1. Power Management and Sleep Modes 3.3.1. Interrupt Vectors in ATmega329P/3290P Electrical Characteristics – TA = -40°C to 85°C <ul style="list-style-type: none"> 3.4.1. Analog Input Offset Voltage (TA = -40°C to 85°C) 3.4.2. Power-Down Specification Limit (TA = -40°C to 85°C) Electrical Characteristics – TA = -40°C to 105°C <ul style="list-style-type: none"> 3.5.1. Analog Input Offset Voltage (TA = -40°C to 105°C) 3.5.2. Power-Down Specification Limit (TA = -40°C to 105°C)

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